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Kathleen M. Ashton

Name

*Kathleen M. Ashton*

Signature

January 9, 2004

Date of Signature

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Anders Kamf

Serial No.: 10/668,931

Filed: September 23, 2003

For: Process for High Strength, High Conductivity  
Copper Alloy of CU-NI-SI Group

INFORMATION DISCLOSURE STATEMENT  
UNDER 37 C.F.R. §1.97

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Applicant wishes to make of record the following references under the provisions of 37 C.F.R. §1.97.

References Cited

Please see attached Information Disclosure Statement by Applicant and copies of references enclosed.

Respectfully submitted,

*David L. Principe*

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Dated: January 8, 2004

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PTO/SB/08A(05/03)

Approved for use through 05/31/2003, OMB 0651-0031

# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use as many sheets as necessary)

Sheet 1 of 1

Application Number 10/668,931  
Filing Date September 23, 2003  
First Named Inventor Anders Kamf  
Art Unit  
Examiner Name  
Attorney Docket Number 38422.0005

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code <sup>2</sup> (if known)			
	1	US-5,846,346	12-08-1998	Lee et al.	
	2	US-5,306,465	04/26/1994	Caron et al.	
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## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Country Code <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (if known)				

Examiner Signature Date Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.